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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





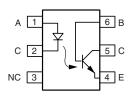


Vishay Semiconductors



Optocoupler, Phototransistor Output, with Base Connection





DESCRIPTION

The IL1, IL2, IL5 are optically coupled isolated pairs employing GaAs infrared LEDs and silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the drive while maintaining a high degree of electrical isolation between input and output. The IL1, IL2, IL5 are especially designed for driving medium-speed logic and can be used to eliminate troublesome ground loop and noise problems. These couplers can be used also to replace relays and transformers in many digital interface applications such as CRT modulation.

FEATURES

- Current transfer ratio (see order information)
- Isolation test voltage 5300 V_{RMS}
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC





AGENCY APPROVALS

- UL1577, file no. E52744 system code H or J, double protection
- DIN EN 60747-5-5 (VDE 0884) available with option 1
- BSI IEC 60950; IEC 60065

ORDER INFORMATION	
PART	REMARKS
IL1	CTR > 20 %, DIP-6
IL2	CTR > 100 %, DIP-6
IL5	CTR > 50 %, DIP-6
IL1-X006	CTR > 20 %, DIP-6 400 mil (option 6)
IL2-X006	CTR > 100 %, DIP-6 400 mil (option 6)
IL2-X009	CTR >100 %, SMD-6 (option 9)
IL5-X009	CTR > 50 %, SMD-6 (option 9)

Note

For additional information on the available options refer to option information.

ABSOLUTE MAXIMUM RATINGS (1)								
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT			
INPUT	•							
Reverse voltage			V_{R}	6	V			
Forward current			I _F	60	mA			
Surge current			I _{FSM}	2.5	Α			
Power dissipation			P _{diss}	100	mW			
Derate linearly from 25 °C				1.33	mW/°C			
OUTPUT								
		IL1	BV _{CEO}	50	V			
Collector emitter breakdown voltage		IL2	BV _{CEO}	70	V			
		IL5	BV _{CEO}	70	V			
Emitter base breakdown voltage			BV _{EBO}	7	V			
Collector base breakdown voltage			BV _{CBO}	70	V			
Callagtar aurrent			I _C	50	mA			
Collector current	t < 1.0 ms		I _C	400	mA			
Power dissipation			P _{diss}	200	mW			
Derate linearly from 25 °C				2.6	mW/°C			



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ABSOLUTE MAXIMUM RATINGS (1)									
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT				
COUPLER	·								
Package power dissipation			P _{tot}	250	mW				
Derate linearly from 25 °C				3.3	mW/°C				
Isolation test voltage between emitter and detector			V _{ISO}	5300	V_{RMS}				
Creepage distance				≥ 7	mm				
Clearance distance				≥ 7	mm				
Comparative tracking index per DIN IEC 112/VDE 0303, part 1			СТІ	175					
Isolation resistance	V _{IO} = 500 V, T _{amb} = 25 °C		R _{IO}	≥ 10 ¹²	Ω				
isolation resistance	V _{IO} = 500 V, T _{amb} = 100 °C		R _{IO}	≥ 10 ¹¹	Ω				
Storage temperature			T _{stg}	- 40 to + 150	°C				
Operating temperature			T _{amb}	- 40 to + 100	°C				
Junction temperature			Tj	100	°C				
Soldering temperature (2)	2.0 mm from case bottom		T _{sld}	260	°C				

Notes

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

(2) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

ELECTRICAL CHARACTERISTICS									
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT			
INPUT									
Forward voltage	I _F = 60 mA	V _F		1.25	1.65	V			
Breakdown voltage	I _R = 10 μA	V_{BR}	6	30		V			
Reverse current	V _R = 6.0 V	I _R		0.01	10	μΑ			
Capacitance	V _R = 0 V, f = 1.0 MHz	Co		40		pF			
Thermal resistance junction to lead		R _{thjl}		750		K/W			
OUTPUT				•					
Collector emitter capacitance	V _{CE} = 5.0 V, f = 1.0 MHz	C _{CE}		6.8		pF			
Collector base capacitance	V _{CB} = 5.0 V, f = 1.0 MHz	C _{CB}		8.5		pF			
Emitter base capacitance	$V_{EB} = 5.0 \text{ V}, f = 1.0 \text{ MHz}$	C _{EB}		11		pF			
Collector emitter leakage voltage	V _{CE} = 10 V	I _{CEO}		5	50	nA			
Collector emitter saturation voltage	$I_{CE} = 1.0 \text{ mA}, I_{B} = 20 \mu\text{A}$	V _{CEsat}		0.25		V			
Base emitter voltage	$V_{CE} = 10 \text{ V}, I_{B} = 20 \mu\text{A}$	V_{BE}		0.65		V			
DC forward current gain	$V_{CE} = 10 \text{ V}, I_B = 20 \mu\text{A}$	h _{FE}	200	650	1800				
DC forward current gain saturated	$V_{CE} = 0.4 \text{ V}, I_B = 20 \mu\text{A}$	h _{FEsat}	120	400	600				
Thermal resistance junction to lead		R _{thjl}		500		K/W			
COUPLER				•					
Capacitance (input to output)	V _{I-O} = 0 V, f = 1.0 MHz	C _{IO}		0.6		pF			
Insulation resistance	V _{I-O} = 500 V	Rs		10 ¹⁴		Ω			

Note

 T_{amb} = 25 °C, unless otherwise specified.

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

 $^{^{(1)}}$ T_{amb} = 25 °C, unless otherwise specified.

IL1, IL2, IL5

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CURRENT TRANSFER RATIO								
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT	
O		IL1	CTR _{CEsat}		75		%	
Current transfer ratio (collector emitter saturated)	$I_F = 10 \text{ mA}, V_{CE} = 0.4 \text{ V}$	IL2	CTR _{CEsat}		170		%	
(conceter elimiter editarated)		IL5	CTR _{CEsat}		100		%	
O	I _F = 10 mA, V _{CE} = 10 V	IL1	CTR _{CE}	20	80	300	%	
Current transfer ratio (collector emitter)		IL2	CTR _{CE}	100	200	500	%	
(conceter entities)		IL5	CTR _{CE}	50	130	400	%	
O	I _F = 10 mA, V _{CB} = 9.3 V	IL1	CTR _{CB}		0.25		%	
Current transfer ratio (collector base)		IL2	CTR _{CB}		0.25		%	
(55,155,15,15,15)		IL5	CTR _{CB}		0.25		%	

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
NON-SATURATED		1	1 ******				
		IL1			20		
Current time	$V_{CE} = 5 \text{ V}, R_L = 75 \Omega,$	IL2	I _F		4		mA
	t _P measured at 50 % of output	IL5	1 1		10		
	V_{CE} = 5 V, R_L = 75 Ω , t_P measured at 50 % of output	IL1			0.8		
Delay time		IL2	t _D		1.7		μs
		IL5			1.7		
		IL1			1.9		
Rise time	$V_{CE} = 5 \text{ V}, R_L = 75 \Omega,$ t_P measured at 50 % of output	IL2	t _r		2.6		μs
	th measured at 50 % of output	IL5			2.6		
Storage time	V_{CE} = 5 V, R_L = 75 Ω , t_P measured at 50 % of output	IL1			0.2		
		IL2	ts		0.4		μs
		IL5			0.4		
Fall time	V_{CE} = 5 V, R_L = 75 Ω , t_P measured at 50 % of output	IL1			1.4		
		IL2	t _f		2.2		μs
		IL5			2.2		
	$V_{CE} = 5 \text{ V}, R_L = 75 \Omega,$ t_P measured at 50 % of output	IL1			0.7		
Propagation H to L		IL2	t _{PHL}		1.2		μs
	tp measured at 30 % or output	IL5			1.1		
		IL1			1.4		
Propagation L to H	$V_{CE} = 5 \text{ V}, R_L = 75 \Omega,$ t_P measured at 50 % of output	IL2	t _{PLH}		2.3		μs
	tp measured at 30 % or output	IL5			2.5		
SATURATED		1	•		•	•	
		IL1			20		
Current time	$V_{CE} = 0.4 \text{ V}, R_{L} = 1.0 \text{ k}\Omega,$ $V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	IL2	I _F		5		mA
	VCL = 5 V, VIH = 1.5 V	IL5			10		
		IL1			0.8		
Delay time	$V_{CE} = 0.4 \text{ V}, R_{L} = 1.0 \text{ k}\Omega,$ $V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	IL2	t _D		1		μs
	VCL = 5 V, VIH = 1.5 V	IL5			1.7		
	V 04V B 4615	IL1			1.2		
Rise time	$V_{CE} = 0.4 \text{ V}, R_{L} = 1.0 \text{ k}\Omega,$ $V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	IL2	t _r		2		μs
	VCL - 5 V, VIH - 1.5 V	IL5			7		
		IL1			7.4		
Storage time	$V_{CE} = 0.4 \text{ V}, R_{L} = 1.0 \text{ k}\Omega,$ $V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	IL2	t _S		5.4		μs
	VCL - 5 V, VIH - 1.5 V	IL5	1		4.6	1	1



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SWITCHING CHARACTERISTICS								
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT	
SATURATED								
Fall time $ \begin{array}{c} \mbox{V}_{CE} = 0.4 \mbox{ V, R}_{L} = 1.0 \mbox{ k}\Omega, \\ \mbox{V}_{CL} = 5 \mbox{ V, V}_{TH} = 1.5 \mbox{ V} \\ \end{array} $	IL1			7.6				
		IL2	t _f		13.5		μs	
		IL5			20			
	$V_{CE} = 0.4 \text{ V}, R_L = 1.0 \text{ k}\Omega, \ V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	IL1	t _{PHL}		1.6			
Propagation H to L		IL2			5.4		μs	
		IL5			2.6			
Propagation L to H	$V_{CE} = 0.4 \text{ V}, R_L = 1.0 \text{ k}\Omega,$ $V_{CI} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	IL1			8.6			
		IL2	t _{PLH}		7.4		μs	
	- CL = 3 1, VIH = 1.0 V	IL5			7.2			

COMMON MODE TRANSIENT IMMUNITY									
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Common mode rejection output high	$V_{CM} = 50 \ V_{P-P}, \ R_L = 1 \ k\Omega, \ I_F = 10 \ mA$		CM _H		5000		V/μs		
Common mode rejection output low	$V_{CM} = 50 \ V_{P-P}, \ R_L = 1 \ k\Omega, \ I_F = 10 \ mA$		CM _L		5000		V/µs		
Common mode coupling capacitance			C _{CM}		0.01		pF		

TYPICAL CHARACTERISTICS

 T_{amb} = 25 °C, unless otherwise specified

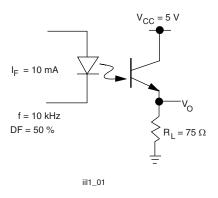


Fig. 1 - Non-Saturated Switching Schematic

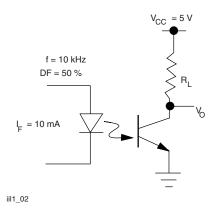


Fig. 2 - Saturated Switching Schematic

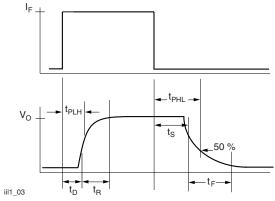


Fig. 3 - Non-Saturated Switching Timing

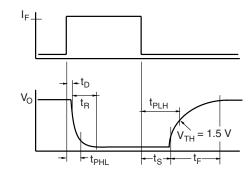


Fig. 4 - Saturated Switching Timing

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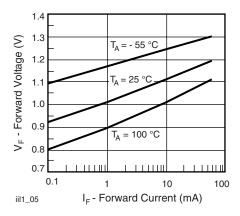


Fig. 5 - Forward Voltage vs. Forward Current

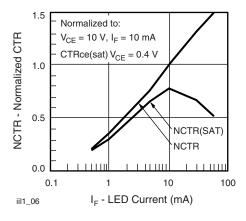


Fig. 6 - Normalized Non-Saturated and Saturated CTR vs. LED Current

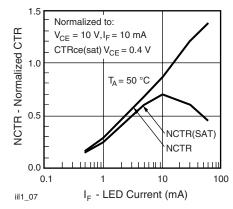


Fig. 7 - Normalized Non-Saturated and Saturated CTR vs. LED Current

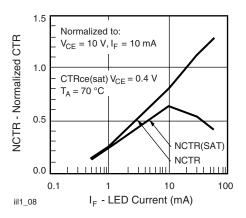


Fig. 8 - Normalized Non-Saturated and Saturated CTR vs. LED Current

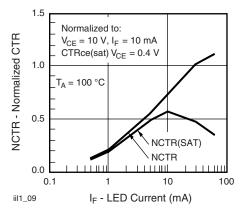


Fig. 9 - Normalized Non-Saturated and Saturated CTR, $T_{amb} = 100~^{\circ}\text{C}$ vs. LED Current

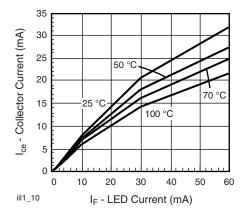


Fig. 10 - Collector Emitter Current vs. Temperature and LED Current



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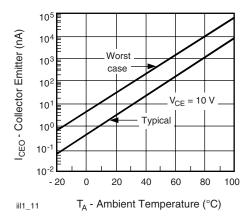


Fig. 11 - Collector Emitter Leakage Current vs.Temperature

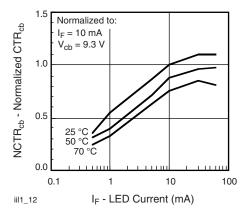


Fig. 12 - Normalized CTR_{cb} vs. LED Current and Temperature

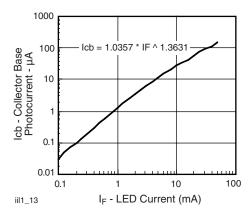


Fig. 13 - Collector Base Photocurrent vs. LED Current

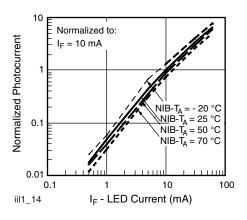


Fig. 14 - Normalized Photocurrent vs. I_F and Temperature

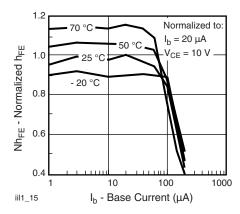


Fig. 15 - Normalized Non-Saturated h_{FE} vs. Base Current and Temperature

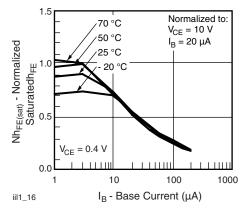


Fig. 16 - Normalized Saturated h_{FE} vs. Base Current and Temperature

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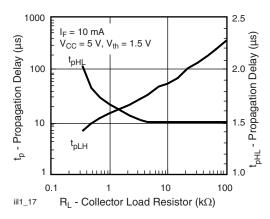
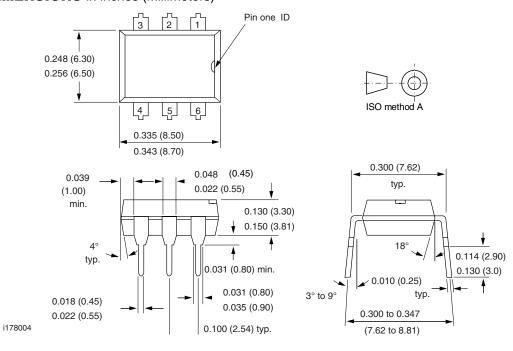
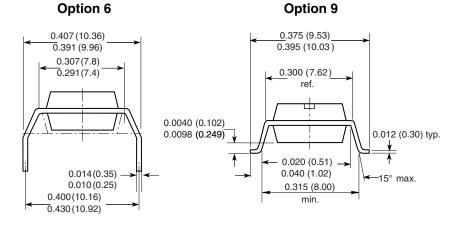


Fig. 17 - Propagation Delay vs. Collector Load Resistor

PACKAGE DIMENSIONS in inches (millimeters)





18493



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OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
- Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



Vishay

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